

# STL52DN4LF7AG

## Automotive-grade dual N-channel 40 V, 9 m $\Omega$ typ., 18 A STripFET™ F7 Power MOSFET in a PowerFLAT™ 5x6 DI

Datasheet - production data

## **Features**

4

3

2

1

Order code	VDS	R <sub>DS(on)</sub> max.	ID
STL52DN4LF7AG	40 V	16 mΩ	18 A

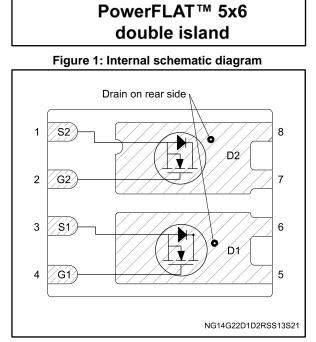
- AEC-Q101 qualified
- Among the lowest R<sub>DS(on)</sub> on the market
- Excellent FoM (figure of merit)
- Low Crss/Ciss ratio for EMI immunity
- High avalanche ruggedness
- Wettable flank package

### Applications

Switching applications

## Description

This N-channel Power MOSFET utilizes STripFET™ F7 technology with an enhanced trench gate structure that results in very low onstate resistance, while also reducing internal capacitance and gate charge for faster and more efficient switching.



#### Table 1: Device summary

Order code	Marking	Package	Packing
STL52DN4LF7AG	52DN4LF7	PowerFLAT™ 5x6 double island	Tape and reel

December 2017

DocID029278 Rev 4

1/16

This is information on a product in full production.

#### Contents

## Contents

1	Electric	al ratings	3
2	Electric	al characteristics	4
	2.1	Electrical characteristics (curves)	6
3	Test cire	cuits	3
4	Package	e information	9
	4.1	PowerFLAT™ 5x6 double island WF type R_package information.1	0
	4.2	Packing information1	3
5	Revisio	n history1	5



## 1 Electrical ratings

Table 2: Absolute maximum ratings

Symbol	Parameter	Value	Unit
V <sub>DS</sub>	Drain-source voltage	40	V
V <sub>GS</sub>	Gate-source voltage	±20	V
I <sub>D</sub> <sup>(1)</sup>	Drain current (continuous) at T <sub>C</sub> = 25 °C	18	А
ID <sup>(1)</sup>	Drain current (continuous) at T <sub>c</sub> = 100 °C	18	А
I <sub>DM</sub> <sup>(1)(2)</sup>	Drain current (pulsed)	72	А
Ртот	Total dissipation at $T_C = 25 \ ^{\circ}C$	65	W
T <sub>stg</sub>	T <sub>stg</sub> Storage temperature range		*0
TJ	Operation junction temperature range	-55 to 175	°C

#### Notes:

 $^{(1)}$ Drain current is limited by package, the current capability of the silicon is 46 A at 25 °C and 33 A at 100 °C.  $^{(2)}$ Pulse width limited by safe operating area

Table 3: Thermal of	data
---------------------	------

Symbol	Parameter	Value	Unit
R <sub>thj</sub> -case	Thermal resistance junction-case	2.3	°C / / /
Rthj-pcb <sup>(1)</sup>	Thermal resistance junction-pcb 32		°C/W

#### Notes:

 $^{(1)}$ When mounted on FR-4 board of 1 inch<sup>2</sup>, 2oz Cu, t < 10 s



## 2 Electrical characteristics

(Tc = 25 °C unless otherwise specified)

Table 4: On/Off states						
Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
$V_{(BR)DSS}$	Drain-source breakdown voltage	$I_D$ = 1 mA, $V_{GS}$ = 0 V	40			V
IDSS	Zero gate voltage drain current	V <sub>GS</sub> = 0 V V <sub>DS</sub> = 40 V			10	μA
lgss	Gate-body leakage current	$V_{GS} = \pm 20 \text{ V},  V_{DS} = 0 \text{ V}$			100	nA
$V_{GS(th)}$	Gate threshold voltage	$V_{\text{DS}}$ = $V_{\text{GS}}$ , $I_{\text{D}}$ = 250 $\mu\text{A}$	1.5		2.5	V
D	Static drain-source	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 6 A		9	16	
RDS(on)	on-resistance	$V_{GS} = 4.5 \text{ V}, I_{D} = 6 \text{ A}$		12	20	mΩ

#### Table 5: Dynamic

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
Ciss	Input capacitance		-	500	-	pF
Coss	Output capacitance	$V_{DS} = 25 V, f = 1 MHz,$	-	140	-	pF
Crss	Reverse transfer capacitance	V <sub>GS</sub> = 0 V		20	-	pF
Qg	Total gate charge	$V_{DD} = 20 \text{ V}, \text{ I}_{D} = 12 \text{ A},$	-	9.4	-	nC
Q <sub>gs</sub>	Gate-source charge	V <sub>GS</sub> = 0 to 10 V	-	1.6	-	nC
Q <sub>gd</sub>	Gate-drain charge	(see Figure 14: "Test circuit for gate charge behavior")	-	2	-	nC

Table 6: Switching times

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
t <sub>d(on)</sub>	Turn-on delay time	$V_{DD} = 32 V, I_D = 6 A,$	-	6.5	-	ns
tr	Rise time	$R_G = 4.7 \Omega$ , $V_{GS} = 10 V$	-	5	-	ns
t <sub>d(off)</sub>	Turn-off delay time	(see Figure 13: "Test circuit for resistive load switching times"	-	48	-	ns
t <sub>f</sub>	Fall time	and Figure 18: "Switching time waveform")	-	14.5	-	ns



#### Electrical characteristics

	Table 7: Source-drain diode					
Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
Isd <sup>(1)</sup>	Source-drain current		-		18	А
ISDM <sup>(2)</sup>	Source-drain current (pulsed)		-		72	A
V <sub>SD</sub> <sup>(3)</sup>	Forward on voltage	I <sub>SD</sub> = 12 A, V <sub>GS</sub> = 0 V	-		1.3	V
t <sub>rr</sub>	Reverse recovery time	I <sub>SD</sub> = 12 A, di/dt = 100 A/µs	-	18		ns
Qrr	Reverse recovery charge	V <sub>DD</sub> = 32 V (see Figure 15: "Test circuit for inductive load switching and diode recovery times")	-	7.5		nC
I <sub>RRM</sub>	Reverse recovery current		-	0.8		А

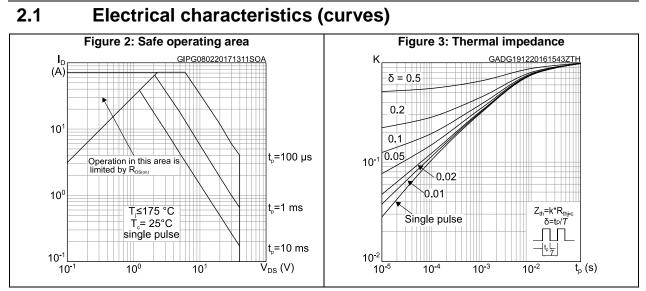
#### Notes:

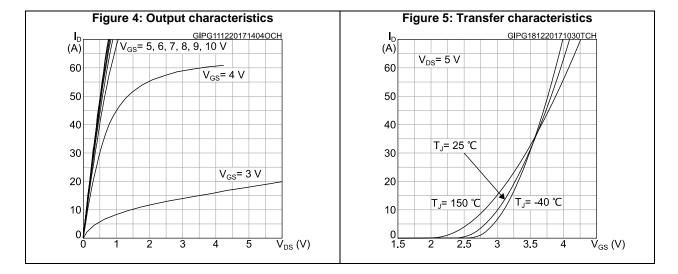
 $^{(1)}\mbox{Drain current}$  is limited by package, the current capability of the silicon is 46 A at 25 °C.

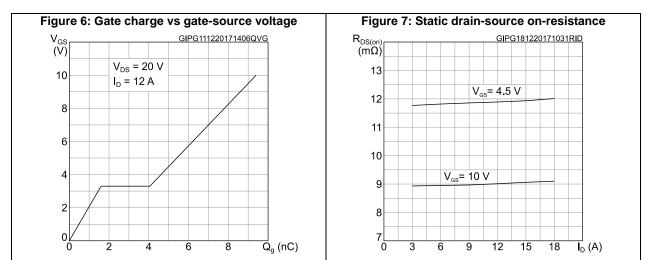
 $^{\left( 2\right) }$  Pulse width limited by safe operating area.

 $^{(3)}\text{Pulsed:}$  pulse duration = 300 µs, duty cycle 1.5%









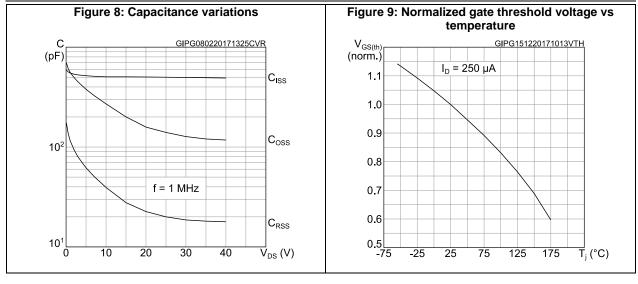
DocID029278 Rev 4

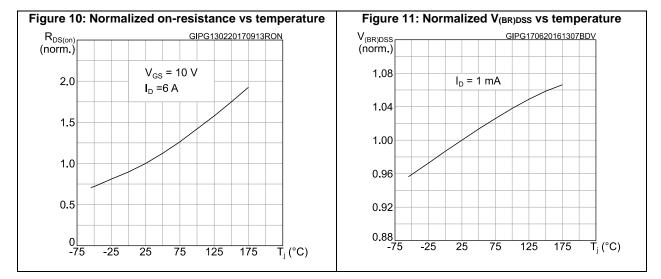


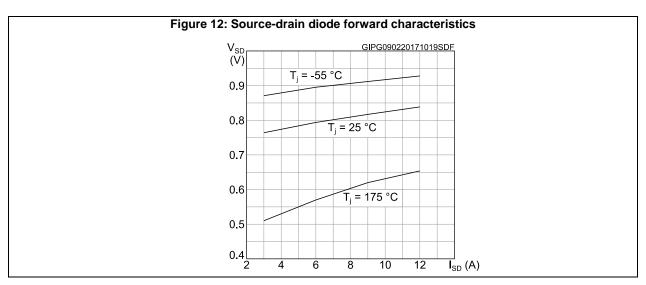
#### STL52DN4LF7AG

57

#### **Electrical characteristics**

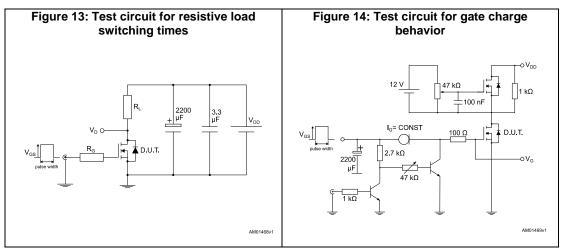


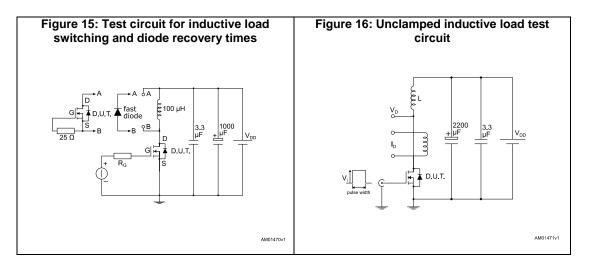


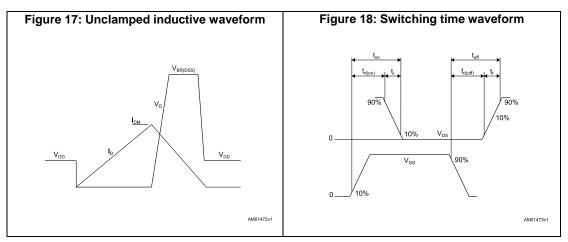


DocID029278 Rev 4

## 3 Test circuits







DocID029278 Rev 4



## 4 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK<sup>®</sup> packages, depending on their level of environmental compliance. ECOPACK<sup>®</sup> specifications, grade definitions and product status are available at: *www.st.com*. ECOPACK<sup>®</sup> is an ST trademark.



# 4.1 PowerFLAT<sup>™</sup> 5x6 double island WF type R package information

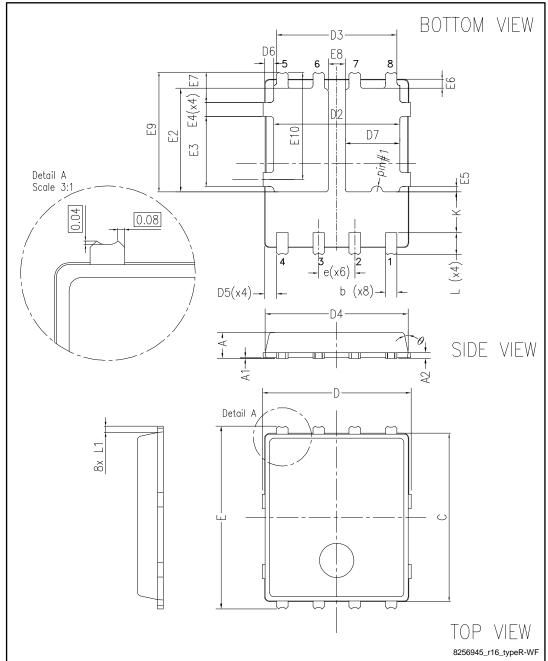


Figure 19: PowerFLAT™ 5x6 double island WF type R package outline



#### STL52DN4LF7AG

Package information

Table 8:	Table 8: PowerFLAT™ 5x6 double island WF type R mechanical data				
Dim.		mm			
Dini.	Min.	Тур.	Max.		
A	0.80		1.00		
A1	0.02		0.05		
A2		0.25			
b	0.30		0.50		
С	5.80	6.00	6.10		
D	5.00	5.20	5.40		
D2	4.15		4.45		
D3	4.05	4.20	4.35		
D4	4.80	5.00	5.10		
D5	0.25	0.40	0.55		
D6	0.15	0.30	0.45		
D7	1.68		1.98		
е		1.27			
E	6.20	6.40	6.60		
E2	3.50		3.70		
E3	2.35		2.55		
E4	0.40		0.60		
E5	0.08		0.28		
E6	0.20	0.325	0.45		
E7	0.85	1.00	1.15		
E8	0.55		0.75		
E9	4.00	4.20	4.40		
E10	3.55	3.70	3.85		
К	1.275		1.575		
L	0.725	0.825	0.925		
L1	0.175	0.275	0.375		
θ	0°		12°		



#### Package information

#### STL52DN4LF7AG

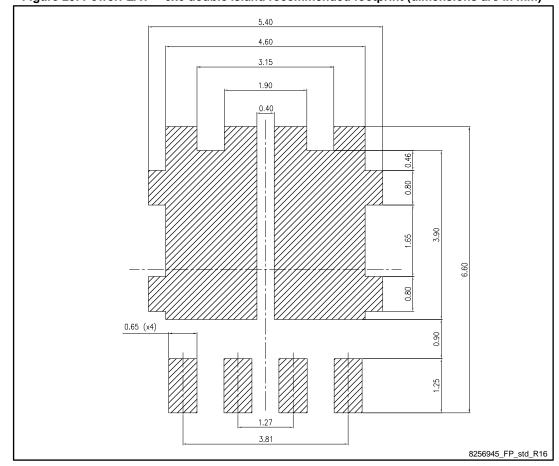
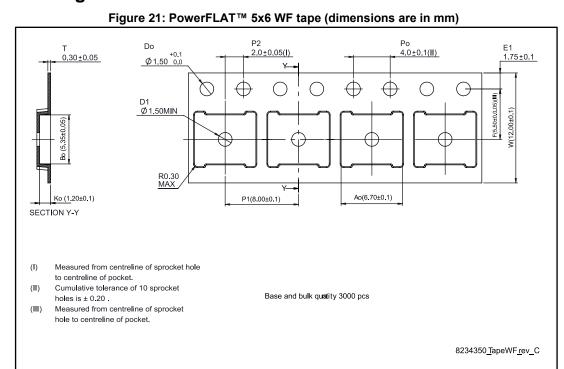


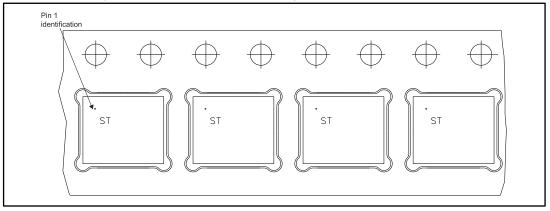
Figure 20: PowerFLAT<sup>™</sup> 5x6 double island recommended footprint (dimensions are in mm)





## 4.2 Packing information

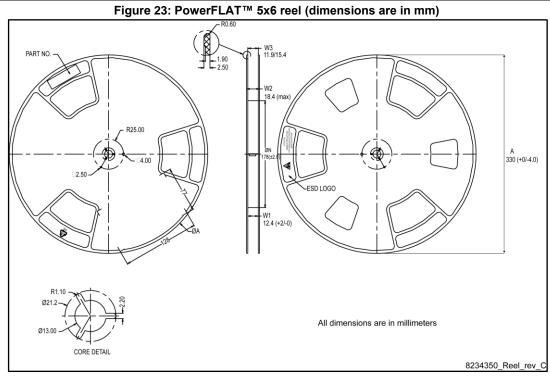
Figure 22: PowerFLAT™ 5x6 package orientation in carrier tape





#### Package information

#### STL52DN4LF7AG





## 5 Revision history

Table 9: Document revision history

Date	Revision	Changes	
28-Apr-2016	1	First release.	
20-Jun-2016	2	Updated Figure 1: "Internal schematic diagram" and Section 7.1: "PowerFLAT™ 5x6 double island WF type R package information" Minor text changes.	
13-Sep-2016	3	Updated Section 5: "Electrical characteristics"	
18-Dec-2017	4	Datasheet promoted from preliminary data to production data. Modified title. Modified Table 4: "On/Off states", Table 5: "Dynamic", Table 6: "Switching times" and Table 7: "Source-drain diode". Added Section 5.1: "Electrical characteristics (curves)". Minor text changes.	



#### IMPORTANT NOTICE - PLEASE READ CAREFULLY

STMicroelectronics NV and its subsidiaries ("ST") reserve the right to make changes, corrections, enhancements, modifications, and improvements to ST products and/or to this document at any time without notice. Purchasers should obtain the latest relevant information on ST products before placing orders. ST products are sold pursuant to ST's terms and conditions of sale in place at the time of order acknowledgement.

Purchasers are solely responsible for the choice, selection, and use of ST products and ST assumes no liability for application assistance or the design of Purchasers' products.

No license, express or implied, to any intellectual property right is granted by ST herein.

Resale of ST products with provisions different from the information set forth herein shall void any warranty granted by ST for such product.

ST and the ST logo are trademarks of ST. All other product or service names are the property of their respective owners.

Information in this document supersedes and replaces information previously supplied in any prior versions of this document.

© 2017 STMicroelectronics - All rights reserved



# **Mouser Electronics**

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

STMicroelectronics: STL52DN4LF7AG